



CE70H270TOAIF

CoreGaN 700V GaN HEMT

Description

The CE70H270TOAIF Series 700V, 270mΩ gallium nitride (GaN) FETs are normally-off devices.

Coreenergy GaN FETs offer better efficiency through lower gate charge, faster switching speeds, and lower dynamic on-resistance, delivering significant advantages over traditional silicon (Si) devices.

Coreenergy is a leading-edge wide band gap supplier with world-class innovation .

Application

- Adapter
- Renewable energy
- Telecom and data-com
- Servo motors
- Industrial
- Automotive

General Features

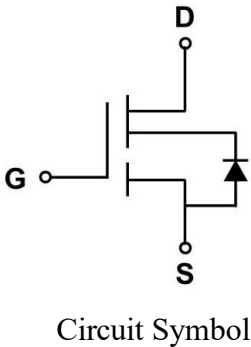
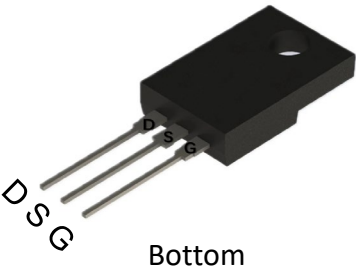
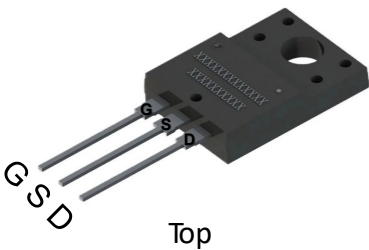
Easy to drive—compatible with standard gate drivers
Low conduction and switching losses
RoHS compliant and Halogen-free

Benefits

Increased efficiency through fast switching
Increased power density
Reduced system size and weight

Ordering Information

Part Number	Package	Package Configuration
CE70H270TOAIF	TO220F	Source



Features

BV_{DSS}	$R_{DS(on)}$	I_{DS}	Q_G
700V	270mΩ	7A	8.7nC



Absolute Maximum Ratings

$T_C=25^{\circ}\text{C}$ unless otherwise stated

Symbol	Parameter		Limit value	Unit
V_{DSS}	Drain to source voltage ($T_J = -55^{\circ}\text{C}$ to 150°C)		700	V
$V_{(TR)DSS}$	Drain to source voltage-transient ^a		850	
V_{GSS}	Gate to source voltage		-20~+20	
I_D	Continuous drain current @ $T_C=25^{\circ}\text{C}$ ^b		7	A
	Continuous drain current @ $T_C=125^{\circ}\text{C}$ ^b		3.2	
I_{DM}	Pulse drain current (pulse width: 10 μs)		14	A
P_D	Maximum power dissipation @ $T_C=25^{\circ}\text{C}$		32	W
T_C	Operating temperature	Case	-55~150	$^{\circ}\text{C}$
T_J		Junction	-55~150	$^{\circ}\text{C}$
T_S	Storage temperature		-55~150	$^{\circ}\text{C}$

a. In off-state, spike duty cycle $D<0.01$, spike duration $<1\mu\text{s}$

b. For increased stability at high current operation



Thermal Resistance

Symbol	Parameter	Limit value	Unit
$R_{\theta JC}$	Junction-to-case	3.9	°C /W



Electrical Parameters

$T_J=25^{\circ}\text{C}$ unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
Forward Device Characteristics						
$V_{(BL)DSS}$	Drain-source voltage	700	-	-	V	$V_{GS}=0\text{V}$
$V_{GS(th)}$	Gate threshold voltage	3.3	3.9	4.5	V	$V_{DS}=1\text{V}, I_{DS}=1\text{mA}$
$\Delta V_{GS(th)}/T_J$	Gate threshold voltage temperature coefficient	-	-7	-	mV/ $^{\circ}\text{C}$	
$R_{DS(on)}$	Drain-source on-Resistance	-	270	320	m Ω	$V_{GS}=10\text{V}, I_D=3\text{A}, T_J=25^{\circ}\text{C}$
		-	570	-		$V_{GS}=10\text{V}, I_D=3\text{A}, T_J=150^{\circ}\text{C}$
I_{DSS}	Drain-to-source leakage current	-	1	10	μA	$V_{DS}=700\text{V}, V_{GS}=0\text{V}, T_J=25^{\circ}\text{C}$
		-	5	100		$V_{DS}=700\text{V}, V_{GS}=0\text{V}, T_J=150^{\circ}\text{C}$
I_{GSS}	Gate-to-source forward leakage current	-	-	± 100	nA	$V_{GS}=\pm 20\text{V}$
C_{ISS}	Input capacitance	-	333	-	pF	$V_{GS}=0\text{V}, V_{DS}=400\text{V}, f=1\text{MHz}$
C_{OSS}	Output capacitance	-	18	-		
C_{RSS}	Reverse capacitance	-	3.7	-		
Q_G	Total gate charge	-	8.7	-	nC	$V_{DS}=400\text{V}, V_{GS}=0\text{V to }10\text{V}, I_D=1\text{A}$
Q_{GS}	Gate-source charge	-	2.2	-		
Q_{GD}	Gate-drain charge	-	2.6	-		
Q_{OSS}	Output charge	-	24	-	nC	$V_{GS}=0\text{V}, V_{DS}=0\text{V to }400\text{V}, f=1\text{MHz}$
$t_{D(on)}$	Turn-on delay	-	5.9	-	ns	$V_{DS}=400\text{V}, V_{GS}=0\text{V to }10\text{V}, I_D=2.1\text{A},$ $R_{G-on(ext)}=6.8\Omega, R_{G-off(ext)}=2.2\Omega,$ $L=250\mu\text{H}$
t_R	Rise time	-	3.4	-		
$t_{D(off)}$	Turn-off delay	-	12.5	-		
t_F	Fall time	-	14.9	-		



Electrical Parameters

T_J=25°C unless otherwise stated

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
Reverse Device Characteristics						
V _{SD}	Source-Drain reverse voltage	-	2.3	-	V	V _{GS} =0V, I _S =5A
t _{RR}	Reverse recovery time	-	14	-	ns	I _s =5A, V _{DD} =400V, di/dt=165A/μs
Q _{RR}	Reverse recovery charge	-	6.5	-	nC	



Typical Characteristics

$T_J = 25^\circ\text{C}$ unless otherwise stated

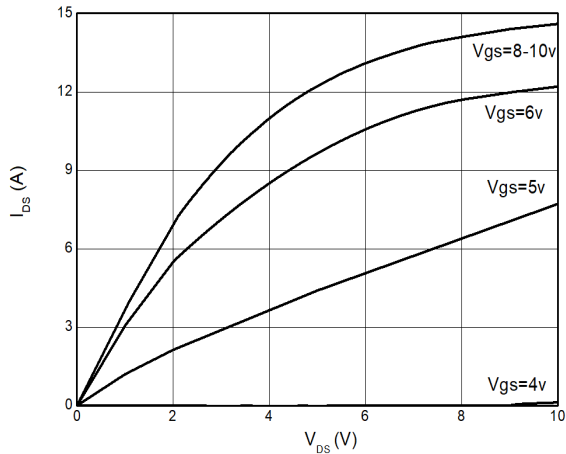


Figure 1. Typical Output Characteristics $T_J = 25^\circ\text{C}$

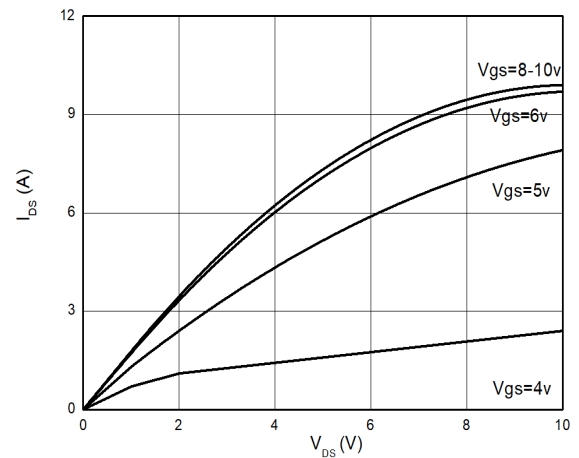


Figure 2. Typical Output Characteristics $T_J = 125^\circ\text{C}$

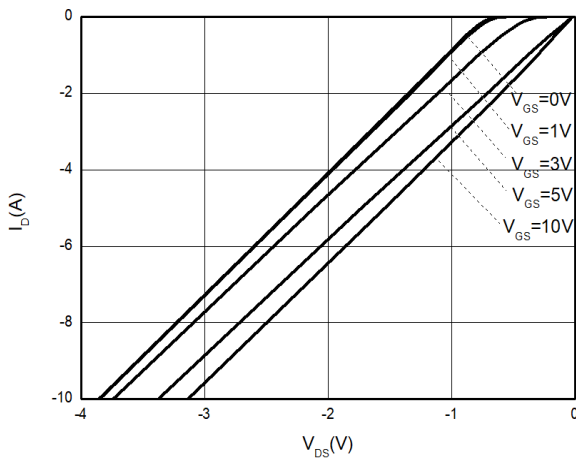


Figure 3. Channel Reverse Characteristics $T_J = 25^\circ\text{C}$

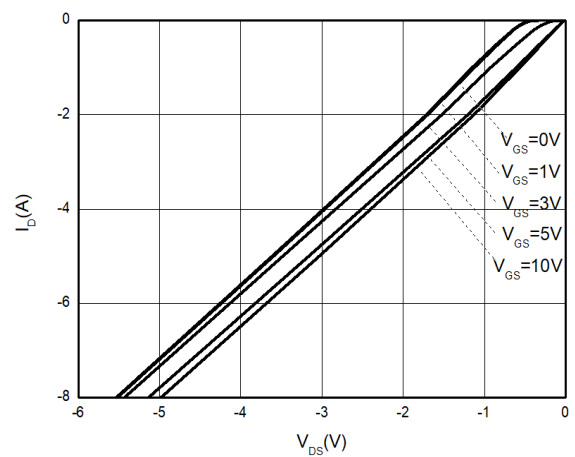


Figure 4. Channel Reverse Characteristics $T_J = 125^\circ\text{C}$



Typical Characteristics

$T_J = 25^\circ\text{C}$ unless otherwise stated

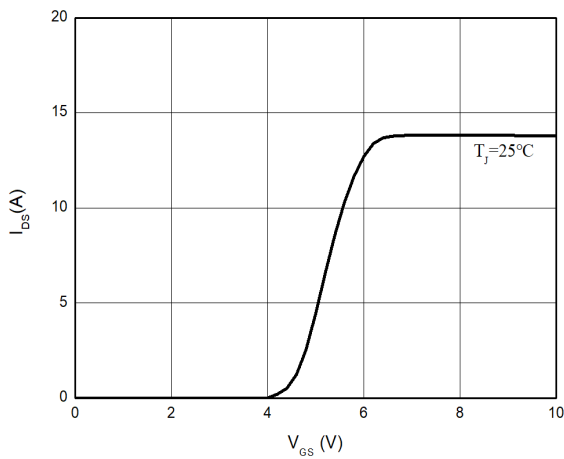


Figure 5. Typical Transfer Characteristics ($V_{DS}=10V$)

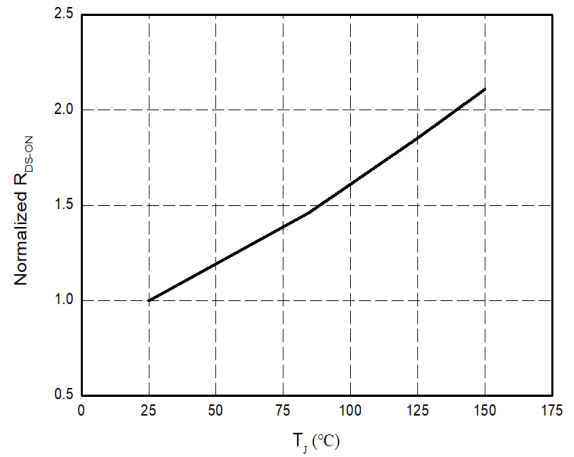


Figure 6. Normalized On-resistance

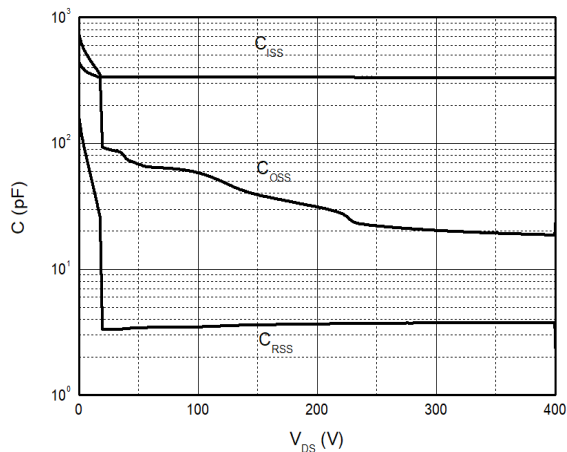


Figure 7. Typical Capacitance ($f=1\text{MHz}$)

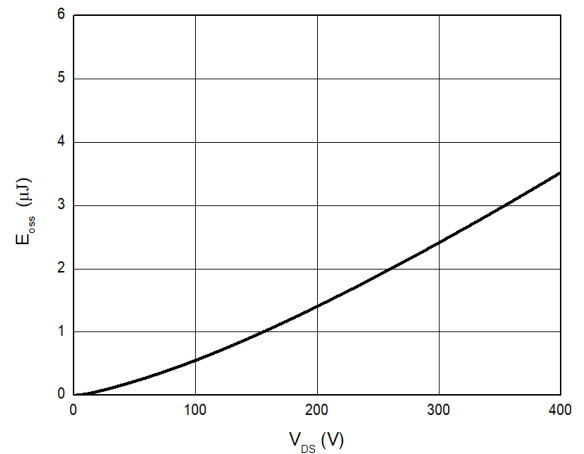


Figure 8. Typical C_{OSS} Stored Energy



Typical Characteristics

$T_J = 25^\circ\text{C}$ unless otherwise stated

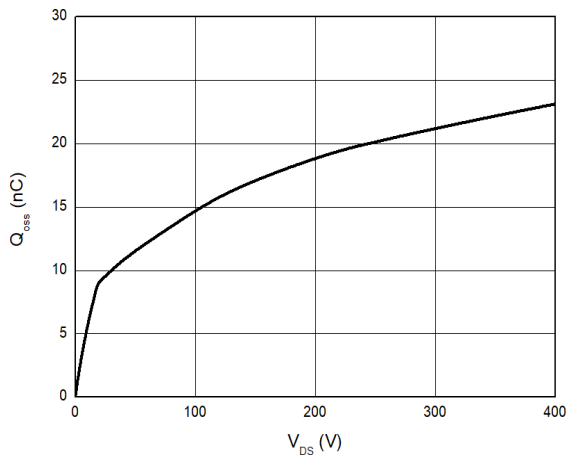


Figure 9. Typical Q_{oss}

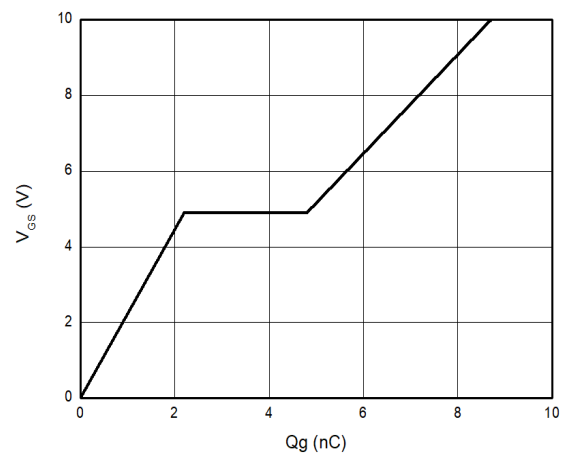


Figure 10. Typical Gate Charge ($V_{DS}=400\text{V}$, $I_D=1\text{A}$)

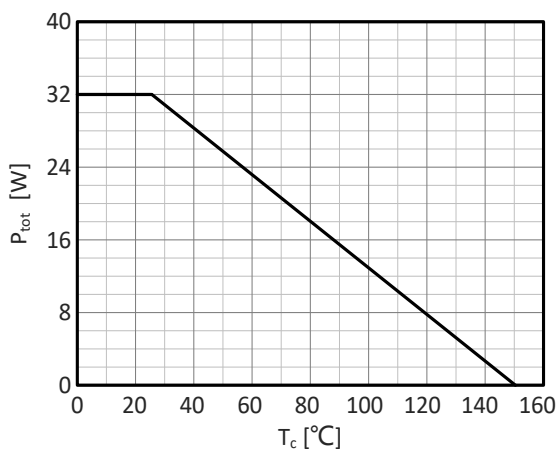


Figure 11. Power Dissipation

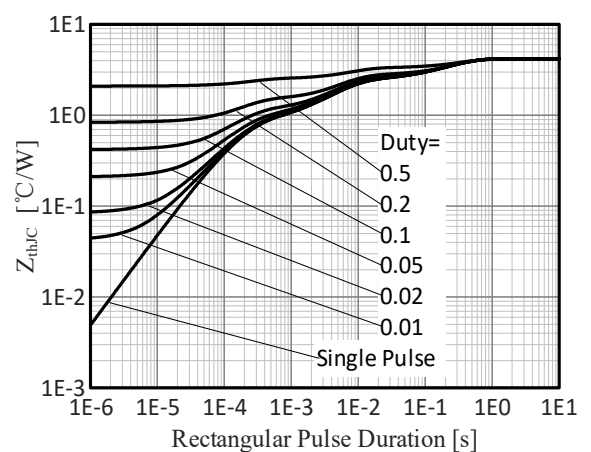


Figure 12. Transient Thermal Resistance



Typical Characteristics

$T_J=25^\circ\text{C}$ unless otherwise stated

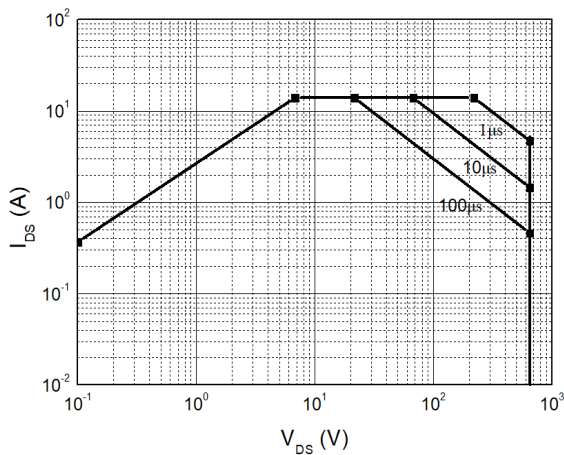


Figure 13. Safe Operating Area $T_c=25^\circ\text{C}$

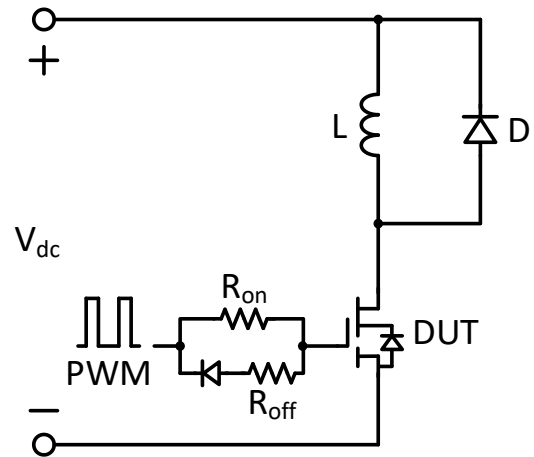


Figure 14. Switching times with inductive load

$V_{DS}=400\text{V}$, $V_{GS}=0\text{V to }10\text{V}$, $I_D=2.1\text{A}$,
 $R_{G-on(ext)}=6.8\Omega$, $R_{G-off(ext)}=2.2\Omega$, $L=250\mu\text{H}$

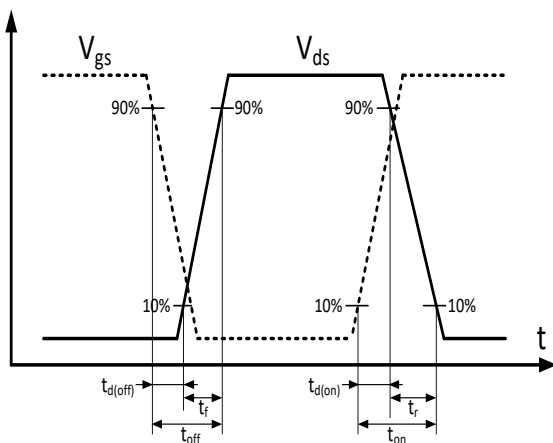


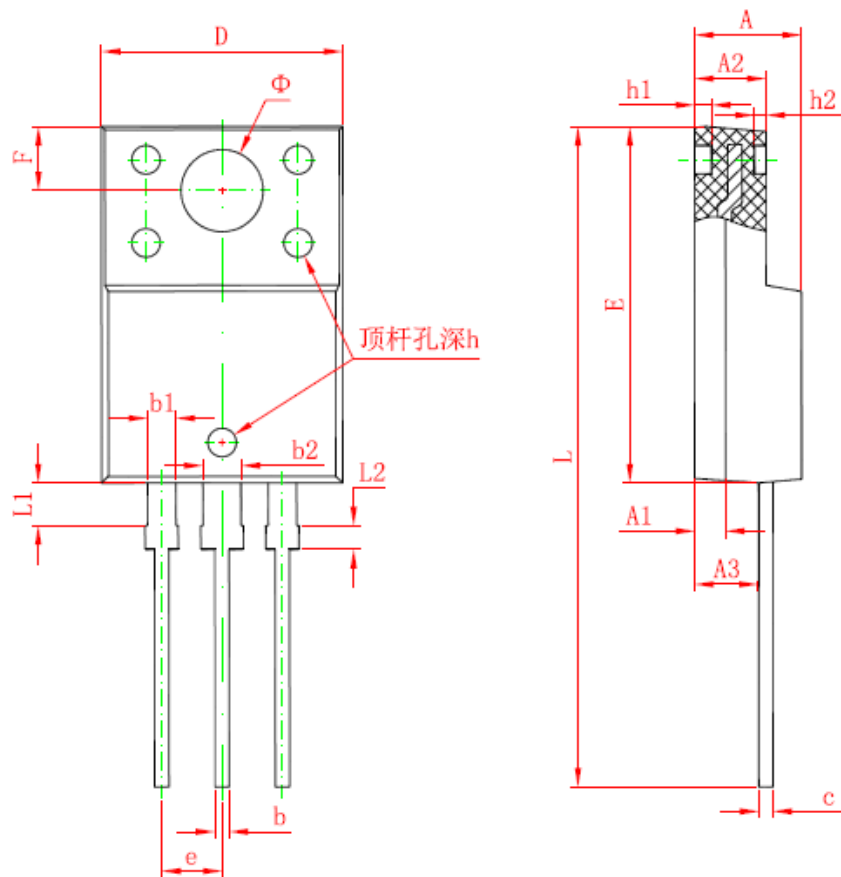
Figure 15. Switching times with waveform



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PACKAGE DIMENSIONS

TO220F-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.300	4.700	0.169	0.185
A1	1.300 REF.		0.051 REF.	
A2	2.800	3.200	0.110	0.126
A3	2.500	2.900	0.098	0.114
b	0.500	0.750	0.020	0.030
b1	1.100	1.350	0.043	0.053
b2	1.500	1.750	0.059	0.069
c	0.500	0.750	0.020	0.030
D	9.960	10.360	0.392	0.408
E	14.800	15.200	0.583	0.598
e	2.540 TYP.		0.100 TYP.	
F	2.700 REF.		0.106 REF.	
Φ	3.500 REF.		0.138 REF.	
h	0.000	0.300	0.000	0.012
h1	0.800 REF.		0.031 REF.	
h2	0.500 REF.		0.020 REF.	
L	28.000	28.400	1.102	1.118
L1	1.700	1.900	0.067	0.075
L2	0.900	1.100	0.035	0.043



CE70H270TOAIF

Revision history

Major changes since the last revision

Revision	Date	Description of changes
1.0	2025-03-01	Initial release